

KINGDOM OF CAMBODIA
Nation Religion King

Ministry of Commerce
Trade Development Support Program (TDSP)
Grant No. TF093573

Invitation for Bids (IFB)

Supply & Installation of a National Phytosanitary Information Management System

IFB No: TDSP/2014/130

1. This Invitation for Bids (IFB) follows the General Procurement Notice (GPN) for the project (TDSP) that appeared in UNDB issue no. 743 posted on 6 January 2009.
2. The Kingdom of Cambodia has received Grant No. TF093573 from the International Development Association (IDA) toward the cost of **Trade Development Support Program (TDSP)**, and it intends to apply part of the proceeds of this grant to payments under the agreement(s) resulting from this IFB. The contract will be first signed for Supply and Installation Costs (including the first year operational costs). The contract for maintaining operations will thereafter be extended annually subject to performance. All subsequent years operational costs will be funded from the above project if it is extended and fund is available; or the internal resources of the Ministry of Agriculture, Forestry and Fisheries.
3. **Ministry of Commerce, Trade Development Support Program (TDSP)**, now invites sealed bids from eligible and qualified bidders for **Supply & Installation of a National Phytosanitary Information Management System**. Bidders may associate to enhance their qualifications.
4. Bidding will be conducted using the National Competitive Bidding (NCB) procedures specified in Procurement Manual for All Externally Financed Projects/Programs in Cambodia, May 2012 and World Bank's Guidelines: Procurement of Goods, Works and Non-Consulting Services under IBRD Loans and IDA Credits & Grants, edition of January 2011. Bidding is opened to all eligible Bidders as defined in the Guidelines that meet the required qualification criteria specified in the bidding documents.
5. Interested eligible Bidders may obtain further information from DICO and inspect the bidding documents at the address given below from **28th April 2015 at 09:00 a.m. to 12:00 p.m and 2.30 p.m. to 5.00 p.m. (Phnom Penh time)**. A pre-bid meeting which potential bidders may attend will be held on **8th May 2015 at 3.00 p.m** (Phnom Penh time) at Ministry of Commerce, Russian Federation Blvd., Phum Toek Thla, Sangkat Toek Thla, Khan Sen Sok, Phnom Penh, Cambodia.
6. A complete set of bidding documents in English may be purchased by interested bidders on the submission of a written application to the address below and upon payment of a non-refundable fee of USD50. The method of payment will be by cash. Bidders who participated in the previous bidding process of this same package will not be charged for the bidding documents. The Bidders must purchase the bidding documents directly from DICO otherwise the Bid will not be accepted.
7. Bids must be delivered to the address below at or before **3.00 p.m. (Phnom Penh time) on 28th May 2015**.
8. Bids need to be secured by a **Bid Securing Declaration**.

9. Bids will be publicly opened in the presence of the bidders' representatives, who choose to attend in person at the address below at **3.00 p.m. on 28th May 2015 (Phnom Penh time)**. Interested public/NGO/Civil societies may also attend the bid opening.
10. The attention of prospective Bidders is drawn to (i) the fact that they will be required to certify in their bids that all software is either covered by a valid license or was produced by the Bidder and (ii) that violations are considered fraud, which can result in ineligibility to be awarded World Bank-financed contracts.
11. The address referred to above for (i) obtaining of information (ii) collection of bidding document; (iii) having difficulty to purchase the bidding document (iv) submission of bid documents and (v) opening of bids, is:

Department of International Cooperation

1st Floor, Ministry of Commerce

Lot 19-61, 113B Road, Russian Federation Blvd, Phum Toek Thla, Sangkat Toek Thla, Khan Sen Sok, Phnom Penh, Cambodia.

Tel: 023 866 064

Attention: Mr. Long Kemvichet, Chief of Procurement

Email: long.kemvichet@gmail.com; cc: chhiengpich@gmail.com; sereyroath.ek@gmail.com; vannarithd@gmail.com; kongsamphy@gmail.com